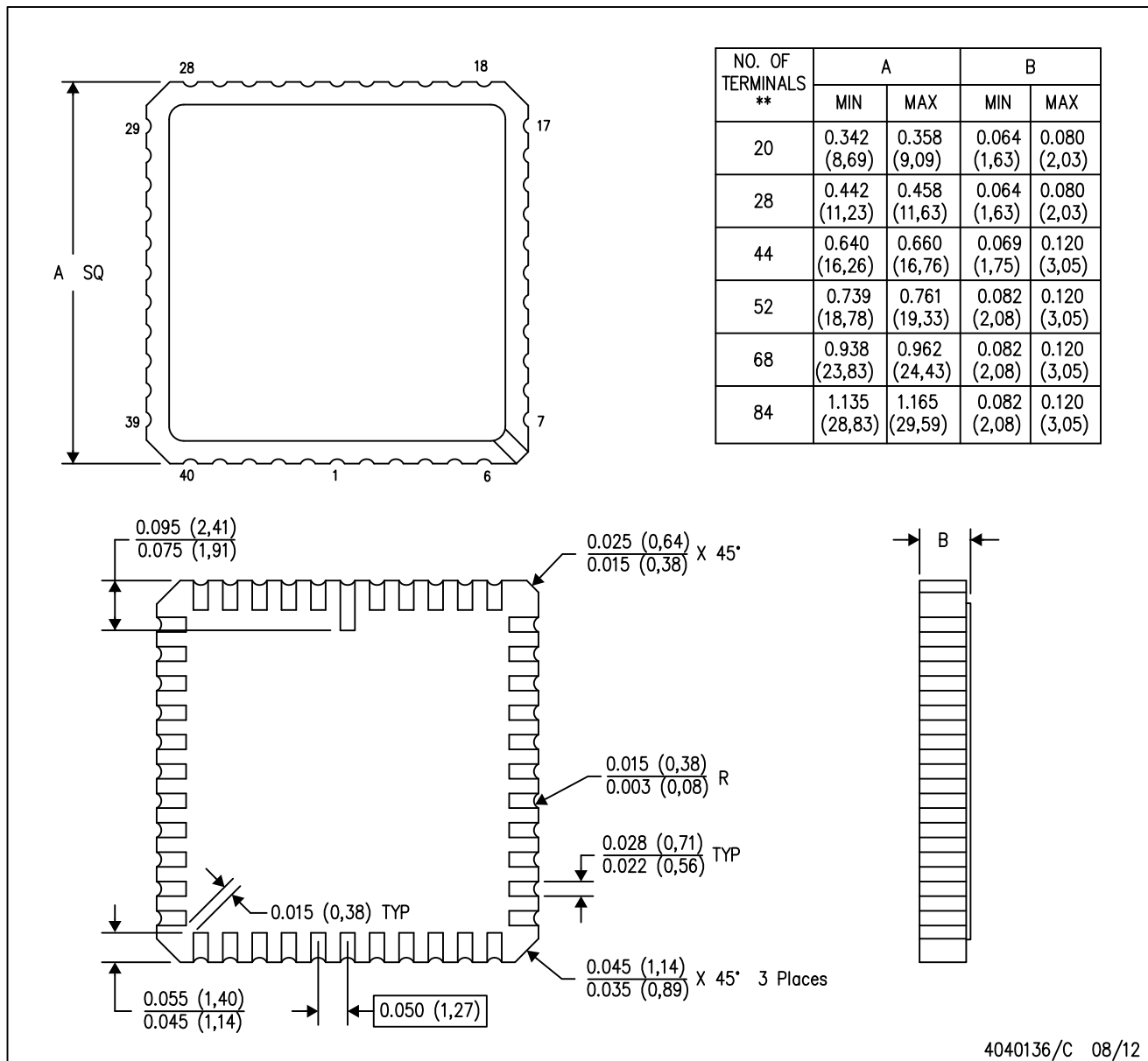


MECHANICAL DATA

FD (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

44 TERMINAL SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals will be gold plated.
 - Falls within JEDEC MS-004.

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